

## First principles modeling of the interface between a solid state lithium thiophosphate electrolyte and a lithium metal anode

N. A. W. Holzwarth

*Department of Physics, Wake Forest University  
Winston-Salem, NC, USA*

Recently, there has been progress in improving the conductivity and stability of solid electrolytes such as  $\text{Li}_3\text{PS}_4$ . [1] For a variety of interface configurations, computer modeling studies show that  $\text{Li}_3\text{PS}_4$  surfaces are structurally and chemically altered by the presence of Li metal. On the other hand, experiments have shown [1] that an electrochemical cell of  $\text{Li}/\text{Li}_3\text{PS}_4/\text{Li}$  can be cycled many times. One possible explanation of the apparent stability of the  $\text{Li}_3\text{PS}_4$  electrolyte/Li metal interface, is that a stable thin buffer layer is formed during the first few cycles. In order to computationally explore this possibility, we modeled a thin film buffer layer of  $\text{Li}_2\text{S}$  on a surface of  $\text{Li}_3\text{PS}_4$ . Using first principles techniques described in previous work, [2] stable electrolyte-buffer layer configurations were found. Results for the idealized configurations indicate that a thin film of  $\text{Li}_2\text{S}$  can provide a protective buffer layer to stabilize the interface between the  $\text{Li}_3\text{PS}_4$  electrolytes and Li metal anodes.

**Acknowledgements:** Nicholas Lepley contributed to a portion of this work. The work was supported by NSF Grant DMR-1105485. Computations were performed on the Wake Forest University DEAC cluster, a centrally managed resource with support provided in part by the University. Helpful discussions with Chengdu Liang and Nancy Dudney of Oak Ridge National Laboratory are gratefully acknowledged.

### **Bibliography:**

- [1] Z. Liu, W. Fu, E. A. Payzant, X. Yu, Z. Wu, N. J. Dudney, J. Kiggans, K. Hong, A. J. Rondinone, and C. Liang, *J. Am. Chem. Soc.* **135**, 975-978 (2013).
- [2] N. A. W. Holzwarth, N. D. Lepley, and Y. A. Du, *J. Power Sources* **196**, 6870-6876 (2011).